

PDM: Rev:H

STATUS: Released

Printed: Aug 11, 2007

PRODUCT NUMBER

51633-001__ NOTE: 2

CONNECTOR NOTES:

I. HOUSING MATERIAL: GLASS FILLED HIGH TEMP THERMOPLASTIC.

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UL94 V-0

SIGNAL CONTACT MATERIAL: COPPER ALLOY POWER CONTACT MATERIAL: COPPER ALLOY

2. PLATING:

51633-001 Singal Pin:30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA,

AND 100u"/2.54um SnPb PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION. Power Pin: 30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA,

AND 100u"/2.54um SnPb PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION.

51633-001LF Singal Pin:30u"/0.76um Au OVER 50u"/I.27um Ni ON }THE CONTACT AREA,

AND 78u"/2.00um Sn PLATING OVER 50u"/I.27um Ni ON THE TERMINATION SECTION.

Power Pin: 30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA,

AND 78u"/2.00um Sn PLATING OVER 50u"/1.27um Ni ÓN THE TERMINATION SECTION.

PART NUMBER 51633-001LF MEETS EUROPEAN UNION DIRECTIVE AND JOTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.

THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A CIRCUIT BOARD.

3. MANUFACTURER NAME, P/N, AND DATE CODE TO APPEAR ON THIS SURFACE.

PCB NOTES:

4. ALL DIMENSIONS ARE BASIC UNLESS OTHERWISE SPECIFIED.

5. ALL THROUGH HOLES ARE LOCATED WITH A TRUE POSITION OF 0.004 [0.10]

6. ALL HOLE DIAMETERS ARE FINISHED HOLE SIZE
7. Ø0.098 [2.49] THROUGH HOLES ARE UNPLATED
8. Ø0.0453±0.0010 [1.151±0.025] DRILLED HOLES PLATED WITH 0.0003 [0.008] MIN SnPb OVER 0.001 [0.03] TO 0.003 [0.08] Cu PLATING TO ACHIEVE A \emptyset 0.040 \pm 0.003 [1.02 \pm 0.07] HOLE.

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form no. 7530-00I-I03

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